

# Diode

Silicon Carbide Schottky Diode

# IDM10G120C5

5<sup>th</sup> Generation CoolSiC™ 1200 V SiC Schottky Diode

# Final Datasheet

Rev. 2.1 2021-06-09

# Industrial Power Control

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### CoolSiC<sup>™</sup> SiC Schottky Diode

#### Features:

- Revolutionary semiconductor material Silicon Carbide
- No reverse recovery current / No forward recovery
- Temperature independent switching behavior
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Excellent thermal performance
- Extended surge current capability
- Specified dv/dt ruggedness
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Pb-free lead plating; RoHS compliant

#### **Benefits**

- System efficiency improvement over Si diodes
- System cost / size savings due to reduced cooling requirements
- Enabling higher frequency / increased power density solutions
- Higher system reliability due to lower operating temperatures
- Reduced EMI
- Related Links: www.infineon.com/sic

#### **Applications**

- Solar inverters
- Uninterruptable power supplies
- Motor drives
- Power Factor Correction

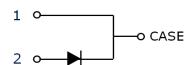
#### Package pin definitions

- Pin 1 and backside cathode
- Pin 2 anode

### **Key Performance and Package Parameters**

Туре	$V_{ m DC}$	<b>I</b> F	$Q_{C}$	$T_{\rm j,max}$	Marking	Package
IDM10G120C5	1200V	10A	41nC	175°C	D1012C5	PG-TO252-2

1) J-STD20 and JESD22

















# 5<sup>th</sup> Generation CoolSiC<sup>™</sup> 1200 V SiC Schottky Diode

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#### **Maximum ratings**

Parameter	Symbol	Value	Unit V	
Repetitive peak reverse voltage	V <sub>RRM</sub>	1200		
Continoues forward current for $R_{th(j-c,max)}$ $T_c = 160$ °C, D=1 $T_c = 135$ °C, D=1 $T_c = 25$ °C, D=1	I <sub>F</sub>	10 18 38		
Surge non-repetitive forward current, sine halfwave $T_C=25$ °C, $t_p=10$ ms $T_C=150$ °C, $t_p=10$ ms	<b>I</b> F,SM	99 84	A	
Non-repetitive peak forward current $T_C = 25$ °C, $t_p = 10$ µs	I <sub>F,max</sub>	711		
i²t value $T_C = 25$ °C, $t_p$ =10 ms $T_C = 150$ °C, $t_p$ =10 ms	∫ i²dt	49 35	A²s	
Diode d $v$ /d $t$ ruggedness $V_R$ =0960 V	d <i>v</i> /d <i>t</i>	150	V/ns	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P <sub>tot</sub>	223	W	
Operating temperature	T <sub>j</sub>	-55175		
Storage temperature	T <sub>stg</sub>	-55150	200	
Soldering temperature, Wave- and reflowsoldering allowed (reflow MSL1)	T <sub>sold</sub>	260	°C	

#### **Thermal Resistances**

Doromotor	C	Com disting a	Value			11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Characteristic						•
Diode thermal resistance, junction – case	R <sub>th(j-c)</sub>		-	0.5	0.7	
Thermal resistance, junction – ambient	D. a.s.	SMD version, device on PCB, minimal footprint	-	-	62	K/W
	R <sub>th(j-a)</sub>	SMD version, device on PCB, 6 cm² cooling area²)		35		

<sup>&</sup>lt;sup>2)</sup> Device on 40 mm\*40mm\*1.5 epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper for cathode connection. PCB is vertical without air stream cooling.



#### **Electrical Characteristics**

#### Static Characteristic, at T<sub>j</sub>=25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
rarameter	Syllibol	Conditions	min.	typ.	max.	Oilit
DC blocking voltage	<b>V</b> <sub>DC</sub>	$T_{\rm j} = 25^{\circ}{\rm C}$	1200	-	-	V
Diode forward voltage	VF	<i>I</i> <sub>F</sub> = 10 A, <i>T</i> <sub>j</sub> =25°C	-	1.5	1.8	\/
Diode forward voltage	VF	<i>I</i> <sub>F</sub> = 10 A, <i>T</i> <sub>j</sub> =150°C	-	2.0	2.6	V
Reverse current		V <sub>R</sub> =1200 V, T <sub>j</sub> =25°C		4	62	^
Reverse current	/R	V <sub>R</sub> =1200 V, T <sub>j</sub> =150°C		22	320	μA

#### Dynamic Characteristics, at $T_j$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
raiaillelei	Syllibol		min.	typ.	max.	Oilit
Total capacitive charge		$V_R = 800 \text{ V}, T_j = 150 ^{\circ}\text{C}$				
	Q <sub>C</sub>	$Q_C = \int_0^{V_R} C(V) dV$	-	41	-	nC
		<i>V</i> <sub>R</sub> =1 V, <i>f</i> =1 MHz	-	525	-	
Total Capacitance	С	<i>V</i> <sub>R</sub> =400 V, <i>f</i> =1 MHz	-	37	-	pF
		<i>V</i> <sub>R</sub> =800 V, <i>f</i> =1 MHz	-	29	1	



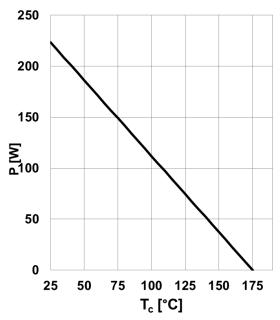


Figure 1. Power dissipation as a function of case temperature,  $P_{tot}$ =f( $T_C$ ),  $R_{th(j-c),max}$ 

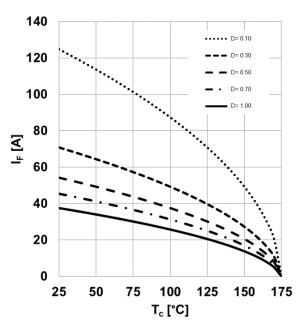


Figure 2. **Diode forward current as function of temperature**,  $T_j$ ≤175°C,  $R_{\text{th(j-c),max}}$ , parameter D=duty cycle,  $V_{\text{th}}$ , Rdiff @  $T_j$ =175°C

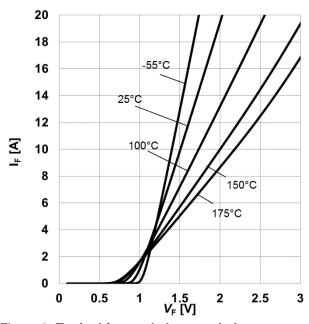


Figure 3. **Typical forward characteristics,**  $I_F = f(V_F)$ ,  $t_p = 10 \mu s$ , parameter:  $T_j$ 

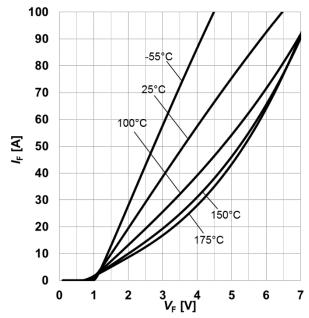


Figure 4. **Typical forward characteristics in surge current,**  $I_F=f(V_F)$ ,  $t_p=10 \mu s$ , parameter:  $T_i$ 



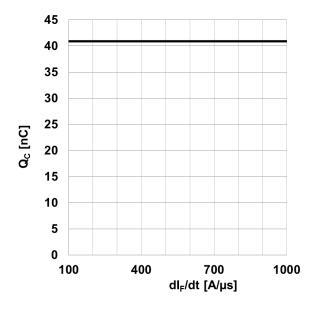


Figure 5. **Typical capacitance charge as function of current slope**<sup>1</sup>,  $Q_C=f(dI_F/dt)$ ,  $T_j=150$ °C 1) Only capacitive charge, guaranteed by design.

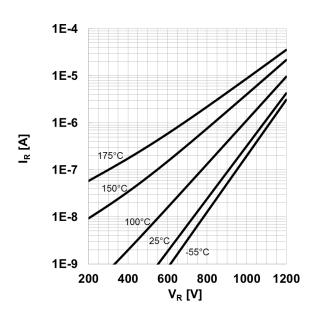


Figure 6. Typical reverse current as function of reverse voltage,  $I_R=f(V_R)$ , parameter:  $T_j$ 

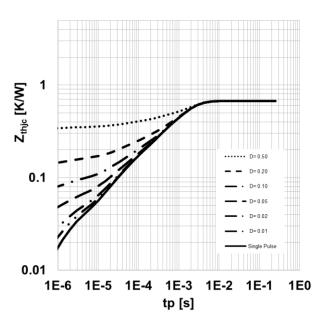


Figure 7. Max. transient thermal impedance,  $Z_{\text{th,jc}} = f(t_P)$ , parameter:  $D = t_P/T$ 

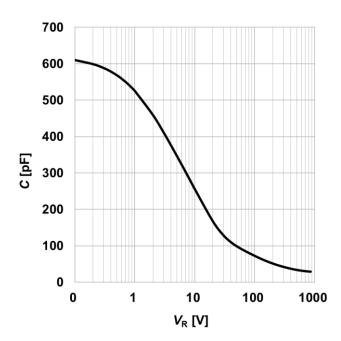


Figure 8. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_i=25$ °C; f=1 MHz



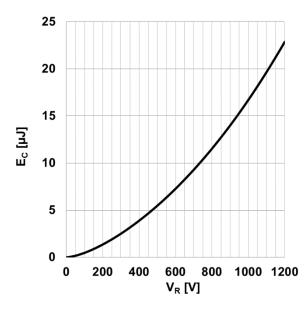
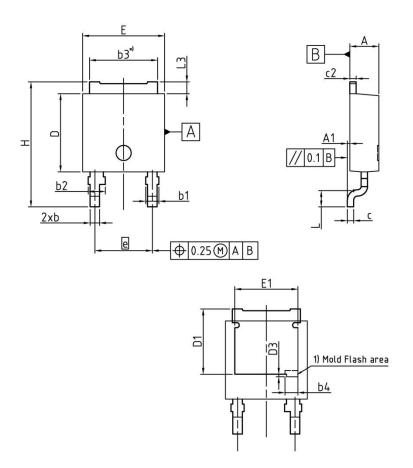


Figure 9. **Typical capacitance stored energy as** function of reverse voltage,

$$E_C = \int_0^{V_R} C(V)VdV$$

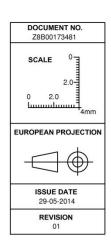


### PG-TO252-2



\*) mold flash not included

DIM	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	2.20	2.35	0.087	0.093	
A1	0.00	0.15	0.000	0.006	
b	0.65	0.85	0.026	0.033	
b1	-	1.15		0.045	
b2	1.05	1.45	0.041	0.057	
b3	5.30	5.50	0.209	0.217	
b4	1.	02	0.040		
С	0.46	0.58	0.018	0.023	
c2	0.46	0.58	0.018	0.023	
D	6.02	6.22	0.237	0.245	
D1	5.04	5.44	0.198	0.214	
E	6.45	6.65	0.254	0.262	
E1	5.	00	0.197		
е	4.57	(BSC)	0.180 (BSC)		
N	2 2		2		
н	9.40	10.40	0.370	0.409	
L	1.19	1.39	0.047	0.055	
D3	0.	20	0.0	008	
L3	0.90	1.10	0.035	0.043	





#### **Revision History**

IDM10G120C5

Revision: 2021-06-09, Rev. 2.1

Previous Revision:

Revision	Date	Subjects (major changes since last version)					
2.0	2015-22-07	Final data sheet					
2.1	2021-06-09	Increased dv/dt ruggedness					

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